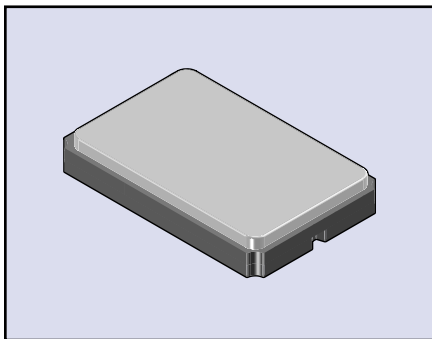


ECX-64A/64C SMD QUARTZ CRYSTAL



The ECX-64A and ECX-64C are subminiature SMD crystals with 3.5 X 6 mm footprint. The cost effective all ceramic package is available in 2 and 4 pad versions. The package height measures 1.1 mm max. which is ideal for densely populated PCB applications.

FEATURES

- Compact and low profile
- Glass sealed ceramic package
- Tape & Reel (1,000 pcs)

PART NUMBERING GUIDE "EXAMPLE"

MANUFACTURER	FREQUENCY (16.0000 MHz)	LOAD CAPACITANCE*	PACKAGE TYPE**
ECS	- 160 -	20	23A

* Load capacitance (xx=xx pF, S=series resonance). **Package Type Examples (23A=ECX-64A, 23C=ECX-64C)

Note: See Product Selection Guide for additional options including tighter tolerances or extended temperature range.

OPERATING CONDITIONS/ELECTRICAL CHARACTERISTICS

PARAMETERS	CONDITIONS	MINIMUM	TYPICAL	MAXIMUM	UNITS
FREQUENCY RANGE		12.600		100.000	MHz
CALIBRATION TOLERANCE	@ +25°C			±30*	PPM
FREQUENCY STABILITY ref @25°C	-10 ~ +70°C			±50*	PPM
SHUNT CAPACITANCE				7	pF
LOAD CAPACITANCE	C _L (Customer Specified)	10	16.0 standard	Series	pF
DRIVE LEVEL	DL			100	µW
OPERATING TEMPERATURE	T _{OPR} **	-10		+70	°C
STORAGE TEMPERATURE	T _{STG}	-40		+85	°C
AGING CHARACTERISTICS (Per Year)	@ +25°C ± 3°C per year			±5	PPM

* Tighter specifications are available. **Extended temperature range available.

EQUIVALENT SERIES RESISTANCE / MODE OF OSCILLATION

FREQUENCY RANGE (MHz)	MODE OF OSC	MAX ESR Ω	FREQUENCY RANGE (MHz)	MODE OF OSC	MAX ESR Ω
12.600 ~ 15.999	Fundamental	80	20.000 ~ 49.999	Fundamental	40
16.000 ~ 19.999	Fundamental	60	50.000 ~ 100.000	3rd O/T	100

PACKAGE DIMENSIONS (mm)

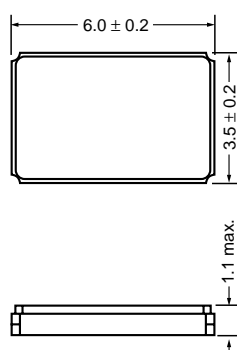


Figure 1) ECX-64A & 64C - Top and side views

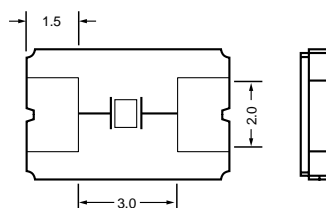


Figure 2) ECX-64A - Pad Configuration Bottom and End views

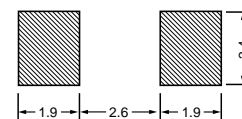


Figure 4) ECX-64A - Recommended Solder Pad Layout

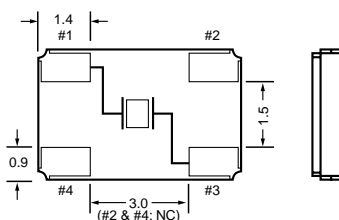


Figure 3) ECX-64C - Pad Configuration Bottom and End views

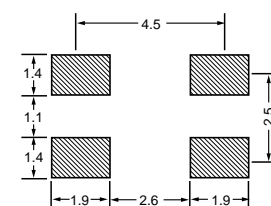


Figure 5) ECX-64C - Recommended Solder Pad Layout